

**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>		Automotive (per AEC-Q100 <sup>††</sup> )	
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.	
<b>Moisture Sensitivity Level</b>		DPAK-3L	MSL1, 260°C (per IPC/JEDEC J-STD-020)
<b>ESD</b>	Machine Model	Class M3 (+/-400V) (per AEC-Q100-003)	
	Human Body Model	Class H1C (+/-2000V) (per AEC-Q100-002)	
	Charged Device Model	Class C4 (+/-1000V) (per AEC-Q100-011)	
<b>IC Latch-Up Test</b>		Class II, Level A (per AEC-Q100-004)	
<b>RoHS Compliant</b>		Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

<sup>††</sup> Exceptions to AEC-Q100 requirements are noted in the qualification report.

<sup>†††</sup> Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

## Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. (T<sub>j</sub>= -40°C..150°C, V<sub>cc</sub>=6..50V unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
V <sub>ds</sub>	Maximum drain to source voltage	-0.3	60	V
V <sub>in</sub>	Maximum input voltage	-0.3	6	V
I <sub>sd</sub> cont.	Max diode continuous current (limited by thermal dissipation) R <sub>th</sub> =50°C/W	—	2.5	A
P <sub>d</sub>	Maximum power dissipation (internally limited by thermal protection) R <sub>th</sub> =50°C/W	—	2.5	W
T <sub>j</sub> max.	Maximum operating junction temperature	-40	150	°C
	Maximum storage temperature	-55	150	

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
R <sub>th1</sub>	Thermal resistance junction to ambient IPS2031R D-Pak std. footprint	70	—	°C/W
R <sub>th2</sub>	Thermal resistance junction to ambient IPS2031R D-Pak 1" sqr. footprint	50	—	
R <sub>th3</sub>	Thermal resistance junction to case IPS2031R D-Pak	2.5	—	

## Recommended Operating Conditions

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
VIH	High level input voltage	4	5.5	
VIL	Low level input voltage	0	0.5	
Ids	Continuous drain current, Tambient=85°C, Tj=125°C, Vin=5V, Rth=70°C/W	—	2.3	A
Rin	Recommended resistor in series with IN pin	Input signal voltage=5V (1)		kΩ
		Input signal voltage=4V (1)		
Max. t rise	Max. input signal rising time (from 10% to 90%)(2)	—	0.5	μs

(1) Input signal of the pulse generator not the voltage on the IN pin of the device. Do not connect any other component on the input.

(2) Max. t<sub>rise</sub> is for the input signal of the pulse generator not on the IN pin voltage of the device

## Static Electrical Characteristics

$T_j = -40..150^{\circ}\text{C}$ ,  $V_{cc} = 6..50\text{V}$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Rds(on)	ON state resistance $T_j = 25^{\circ}\text{C}$	—	45	60	mΩ	$V_{in} = 5\text{V}$ , $I_{ds} = 5\text{A}$
	ON state resistance $T_j = 150^{\circ}\text{C}$	—	80	110		
Idss1	Drain to source leakage current	—	0.1	1	μA	$V_{cc} = 14\text{V}$ , $V_{in} = 0\text{V}$ , $T_j = 25^{\circ}\text{C}$
Idss2	Drain to source leakage current	—	0.15	2		$V_{cc} = 50\text{V}$ , $V_{in} = 0\text{V}$ , $T_j = 25^{\circ}\text{C}$
V clamp1	Drain to source clamp voltage 1	63	68	—	V	$I_d = 20\text{mA}$ See fig. 3 & 4
V clamp2	Drain to source clamp voltage 2	—	68	75		$I_{in} = 1\text{mA}$
Vin clamp	IN to source pin clamp voltage	5.5	6.2	7.5		$I_d = 200\text{mA}$
Vth	Input threshold voltage	1.1	2	2.8		
Iin, on	ON state IN positive current	10	40	80	μA	$V_{in} = 5\text{V}$
Iin, off	OFF state IN positive current ( after protection latched )	120	250	350		

## Switching Electrical Characteristics

$V_{cc} = 28\text{V}$ , Resistive load =  $10\Omega$ ,  $R_{input} = 50\Omega$ ,  $V_{in} = 5\text{V}$ ,  $T_j = 25^{\circ}\text{C}$

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Tdon	Turn-on delay time to 20%	0.5	2	5	μs	See figure 2
Tr	Rise time 20% to 80%	0.2	1.4	3		
Tdoff	Turn-off delay time to 80%	3	8	12		
Tf	Fall time 80% to 20%	0.2	1.4	3		
Eon + Eoff	Turn on and off energy	—	110	—	μJ	

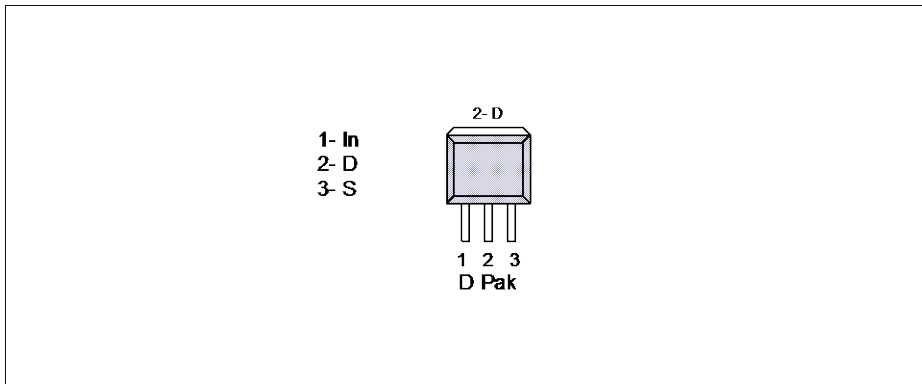
## Protection Characteristics

$T_j = -40..150^{\circ}\text{C}$ ,  $V_{cc} = 6..50\text{V}$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Tsd	Over temperature threshold	150(2)	165	—	$^{\circ}\text{C}$	See figure 1
I <sub>sd</sub>	Over current threshold	10	15	20	A	See figure 1
Vreset	IN protection reset threshold	0.9	1.6	2	V	
Treset	Time to reset protection	15	50	500	μs	$V_{in} = 0\text{V}$ , $T_j = 25^{\circ}\text{C}$

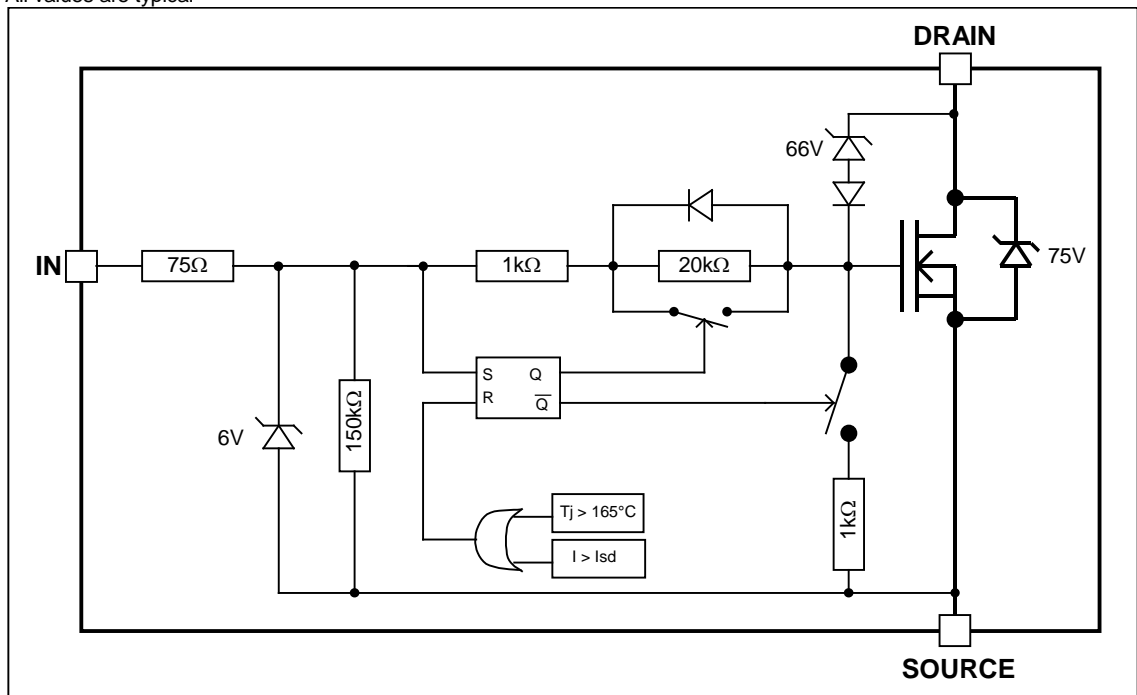
(2) Guaranteed by design

## Lead Assignments



## Functional Block Diagram

All values are typical



All curves are typical values. Operating in the shaded area is not recommended.

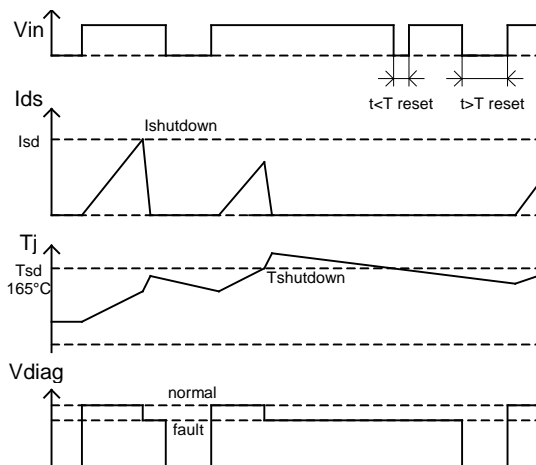


Figure 1 – Timing diagram

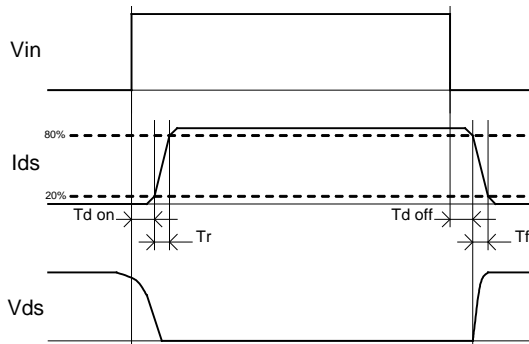


Figure 2 – IN rise time & switching definitions

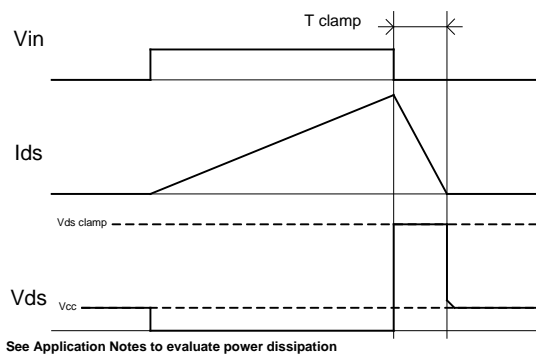


Figure 3 – Active clamp waveforms

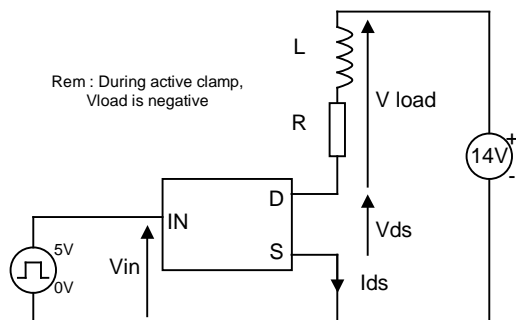
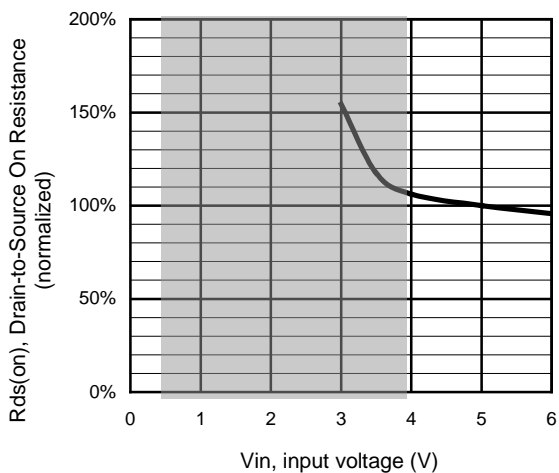
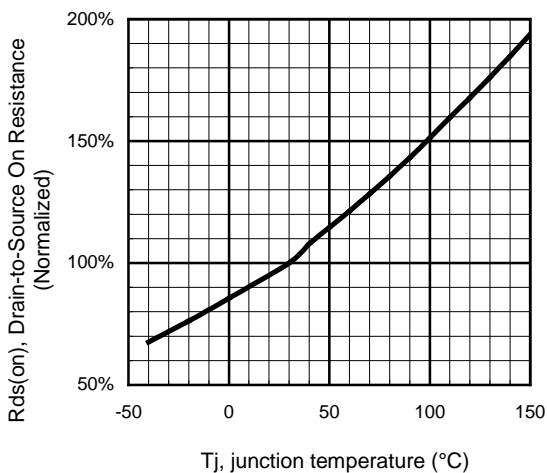
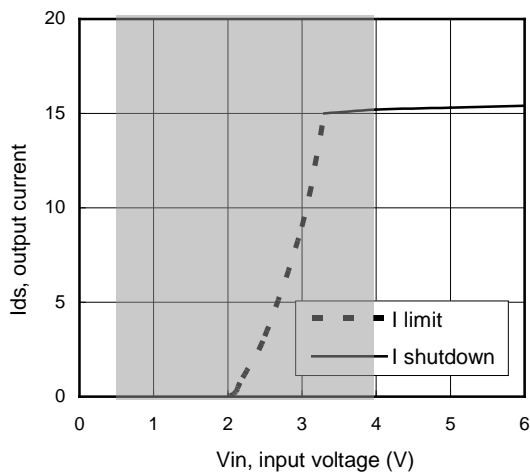
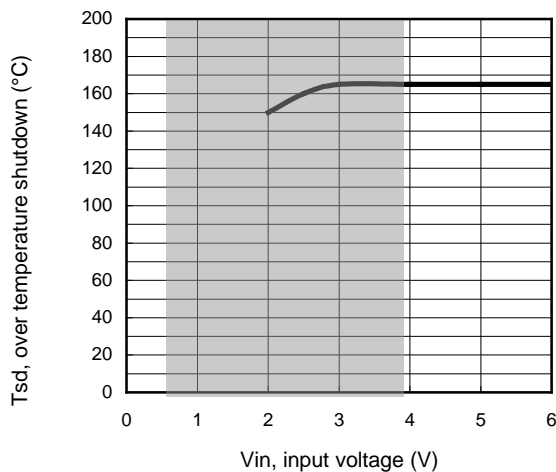
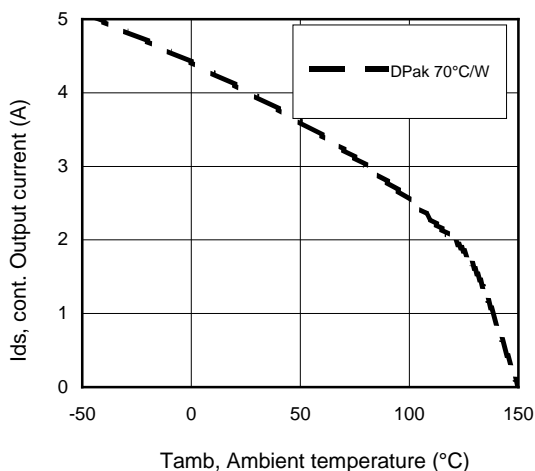
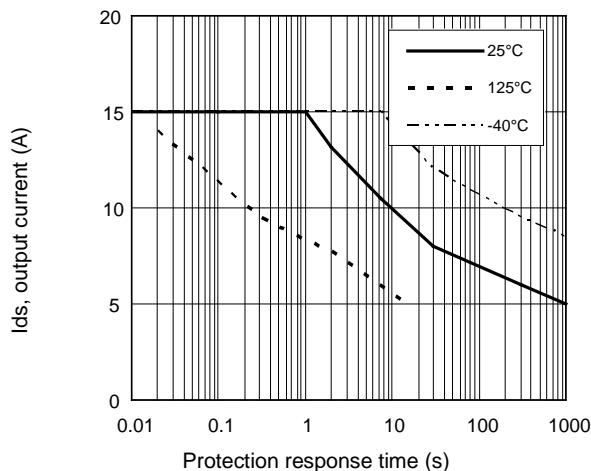


Figure 4 – Active clamp test circuit

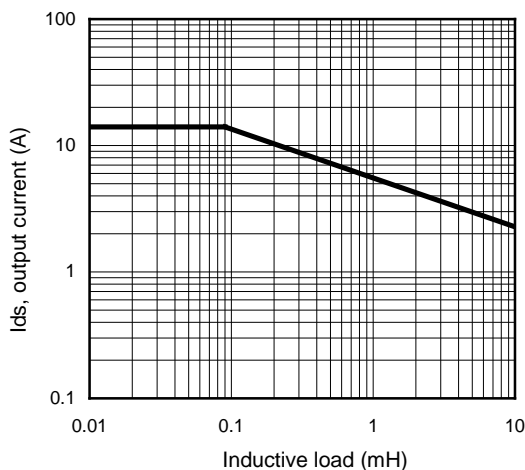

**Figure 5 – Normalized Rds(on) (%) Vs Input voltage (V)**

**Figure 6 - Normalized Rds(on) (%) Vs Tj (°C)**

**Figure 7 – Current limitation and current shutdown Vs Input voltage (V)**

**Figure 8 – Over temperature shutdown (°C) Vs input voltage (V)**



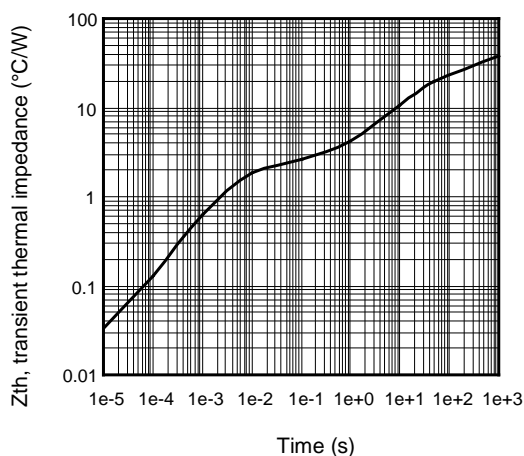
**Figure 9 – Max. continuous output current (A) Vs Ambient temperature (°C)**



**Figure 10 – Ids (A) Vs over temperature protection response time (s)**

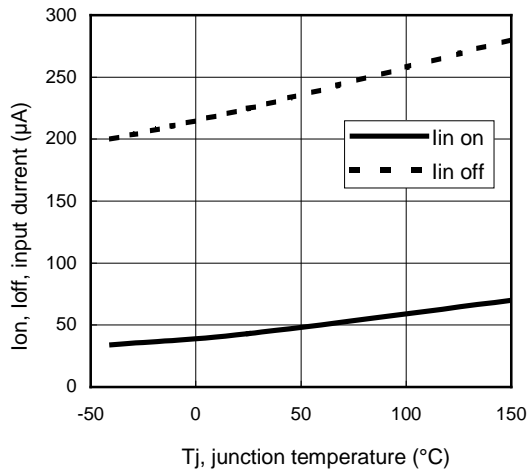


**Figure 11 – Max. output current (A) Vs Inductive load (mH)**



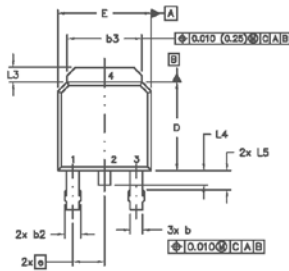
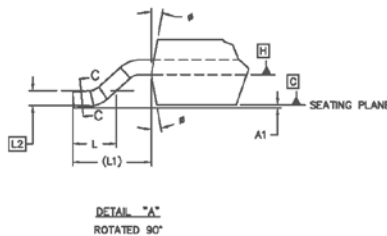
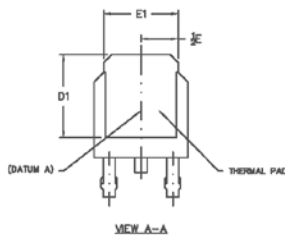
**Figure 12 – Transient thermal impedance (°C/W) Vs time (s)**

This is for single pulse when  $T_j=165^{\circ}\text{C}$  and for repetitive pulses when  $T_j<115^{\circ}\text{C}$  before turning off.

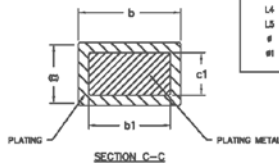
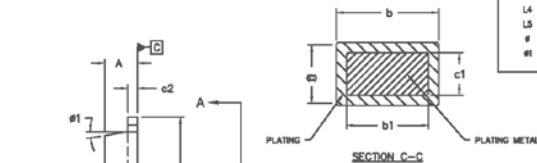


**Figure 13 – Input current (µA) On and Off  
Vs junction temperature (°C)**

## Case outline – Dpak



SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	2.18	2.30	.086	.091	
A1		0.13		.005	
b	0.84	0.89	.033	.035	5
b1	0.84	0.79	.023	0.031	5
b2	0.78	1.14	.030	.045	
b3	4.85	5.48	.195	.215	
c	0.48	0.61	.018	.024	5
c1	0.41	0.55	.016	.022	5
e2	.048	0.89	.018	.035	5
D	5.97	6.22	.235	.245	6
D1	5.21	—	.205	—	4
E	6.35	6.73	.250	.265	6
E1	4.32	—	.170	—	4
e	3.28		.080 BSC		
H	6.40	10.41	.250	.410	
L	1.40	1.78	.055	.070	
L1	2.74 REF.		.100 REF.		
L2	0.81 BSC		.020 BSC		
L3	0.89	1.27	.035	.050	
L4		1.02		.040	
L5	1.14	1.52	.045	.060	3
Ø	Ø	10°	Ø	10°	
Ø1	Ø	10°	Ø	10°	

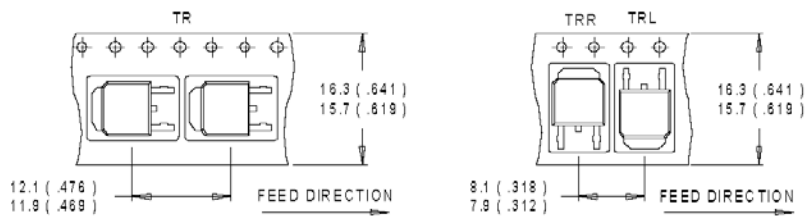


### NOTES:

- 1.0 DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994.
- 2.0 DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS].
- 3.0 LEAD DIMENSION UNCONTROLLED IN L5
- 4.0 DIMENSION D1 AND E1 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.0 SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 [0.127] AND .010 [0.254] FROM THE LEAD TIP.
- 6.0 DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 7.0 OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA.
- 8.0 LEADS AND DRAIN ARE PLATED WITH 100% Sn

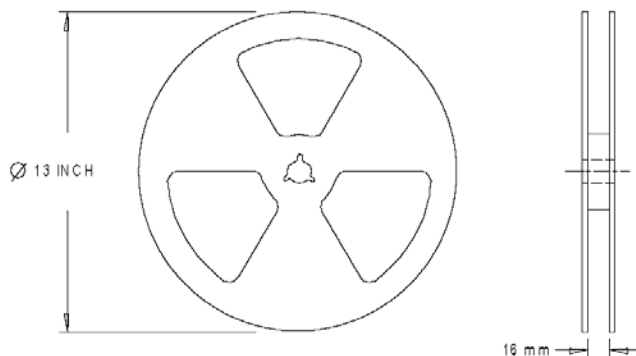
## Tape & Reel – Dpak

Dimensions are shown in millimeters (inches)



### NOTES :

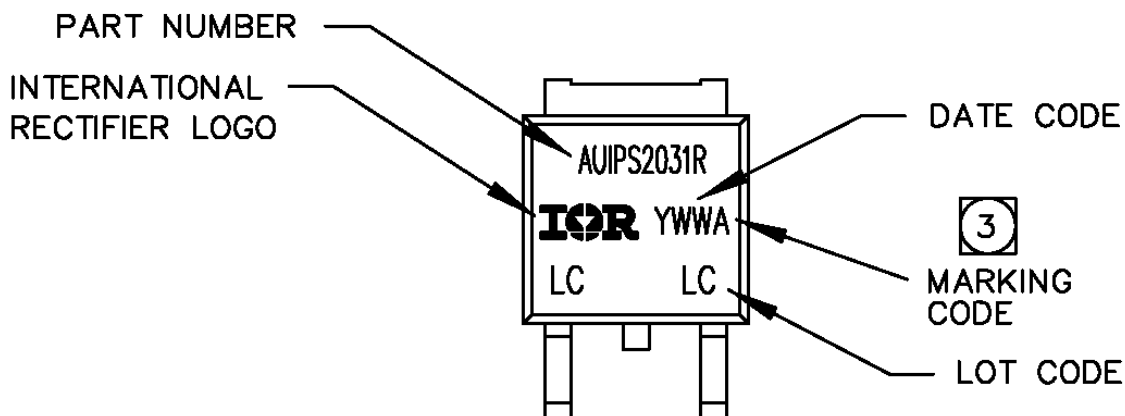
1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS ( INCHES ).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



### NOTES :

1. OUTLINE CONFORMS TO EIA-481.

## Part Marking Information



## Ordering Information

Base Part Number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIPS2031R	D-Pak-5-Lead	Tube	75	AUIPS2031R
		Tape and reel	2000	AUIPS2031RTR
		Tape and reel left	3000	AUIPS2031RTRL
		Tape and reel right	3000	AUIPS2031RTRR

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**WORLD HEADQUARTERS:**

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## Revision History

Revision	Date	Notes/Changes
A4	March, 25 <sup>th</sup> , 2010	Add tri-temp ds
A5	May, 10 <sup>th</sup> 2010	Update before qual
A6	November, 17 <sup>th</sup> 2010	Final release
A7	December, 7 <sup>th</sup> 2010	Remove ESD section page3
A8	December, 9 <sup>th</sup> 2010	Update qual page
B	June, 21 <sup>st</sup> 2012	Update storage temperature
C	December, 3 <sup>rd</sup> 2012	Update switching losses Add a note figure 11
D	April, 18 <sup>th</sup> 2013	Update Recommended Input resistor